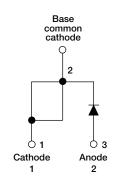


High Voltage Input Rectifier Diode, 60 A







PRODUCT SUMMARY					
Package	TO-247AC modified				
I _{F(AV)}	60 A				
V_{R}	800 V to 1200 V				
V _F at I _F	1.09 V				
I _{FSM}	950 A				
T _J max.	150 °C				
Diode variation	Single die				

FEATURES

 Designed and qualified according JEDEC-JESD47



• Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

RoHS

 Typical applications are in input rectification and these products are designed to be used with Vishay HPP switches and output rectifiers which are available in identical package outlines.

DESCRIPTION

The VS-60EPS..PbF rectifier high voltage series has been optimized for very low forward voltage drop, with moderate leakage. The glass passivation technology used has reliable operation up to 150 $^{\circ}$ C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Sinusoidal waveform	60	А			
V _{RRM}		800/1200	V			
I _{FSM}		950	A			
V _F	60 A, T _J = 25 °C	1.09	V			
T _J		- 40 to 150	°C			

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA			
VS-60EPS08PbF	800	900	1			
VS-60EPS12PbF	1200	1300	1			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	nt I _{F(AV)} T _C = 118 °C, 180° conduction half sine wave		60			
Maximum peak one cycle non-repetitive surge current		10 ms sine pulse, rated V _{RRM} applied	950	A		
		10 ms sine pulse, no voltage reapplied				
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied	4512	A ² s		
Maximum 1-t for fusing		10 ms sine pulse, no voltage reapplied 6300		7.5		
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	63 000	A²√s		



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CON	IDITIONS	VALUES	UNITS	
Maximum forward valtage drap	W	30 A, T _J = 25 °C		1.0	V	
Maximum forward voltage drop	V_{FM}	60 A, T _J = 25 °C		1.09	V	
Forward slope resistance	r _t	T _J = 150 °C		3.96	mΩ	
Threshold voltage	V _{F(TO)}			0.74	V	
Maximum reverse leakage current	I _{RM}	T _J = 25 °C	V _B = Rated V _{BBM}	0.1	mA	
Waxiiiluiii reverse leakage current		T _J = 150 °C	VR = nateu VRRM	1.0	IIIA	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		- 40 to 150	°C	
Maximum thermal resistance, unction to case		R_{thJC}	R _{thJC} DC operation			
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.2		
Approximate weight				6	g	
Approximate weight				0.21	oz.	
Mounting torque	minimum			6 (5)	kgf · cm	
Mounting torque -	maximum			12 (10) (lbf · in)		
Madinadavina			Coop abula TO 247AC modified / IEDEC	60EPS08		
Marking device			Case style TO-247AC modified (JEDEC)		60EPS12	

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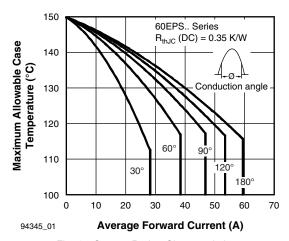


Fig. 1 - Current Rating Characteristics

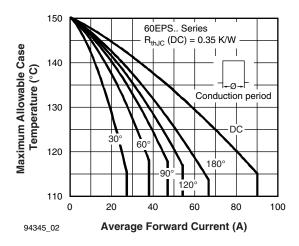


Fig. 2 - Current Rating Characteristics

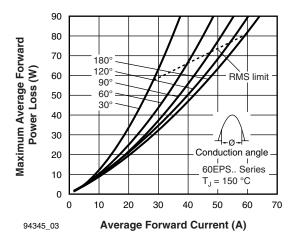


Fig. 3 - Forward Power Loss Characteristics

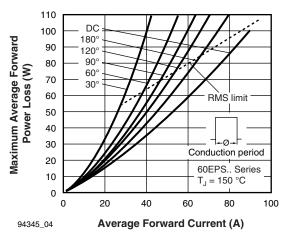


Fig. 4 - Forward Power Loss Characteristics

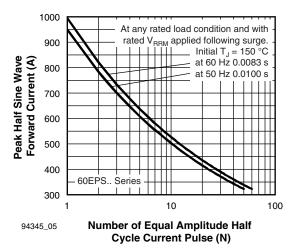


Fig. 5 - Maximum Non-Repetitive Surge Current

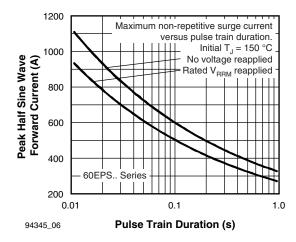


Fig. 6 - Maximum Non-Repetitive Surge Current

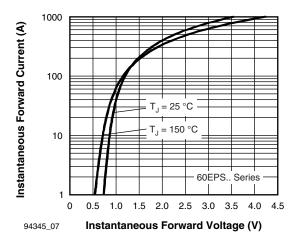


Fig. 7 - Forward Voltage Drop Characteristics

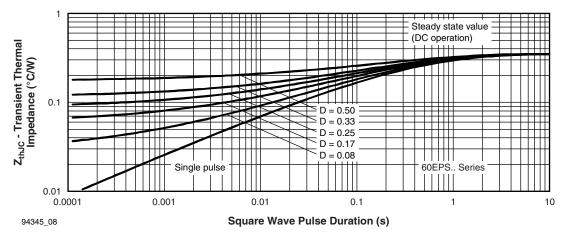
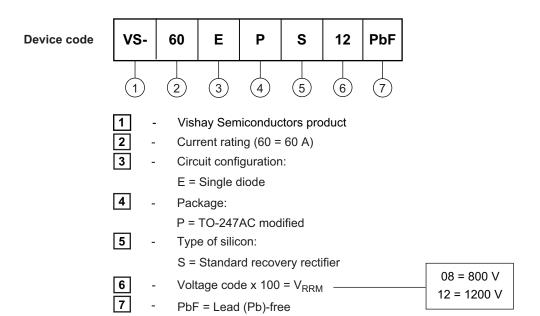


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

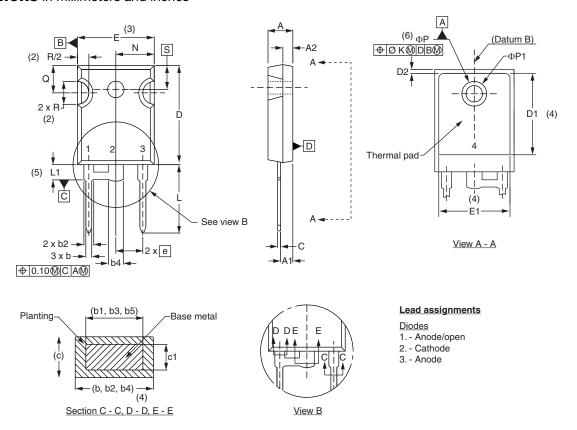
ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95253</u>				
Part marking information	www.vishay.com/doc?95255			



DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	NOTES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.37	0.065	0.094	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.86	0.015	0.034	
c1	0.38	0.76	0.015	0.030	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	MILLIMETERS		INCHES		
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
D2	0.51	1.30	0.020	0.051		
E	15.29	15.87	0.602	0.625	3	
E1	13.72	-	0.540	1		
е	5.46	BSC	0.215	BSC		
ΦК	2.54		0.0	10		
L	14.20	16.10	0.559	0.634		
L1	3.71	4.29	0.146	0.169		
N	7.62	BSC	0	.3		
ΦР	3.56	3.66	0.14	0.144		
ФР1	-	6.98	-	0.275		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	1.78	0.216		
S	5.51 BSC		0.217	BSC		

Notes

- (1) Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) ΦP to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c





Vishay

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